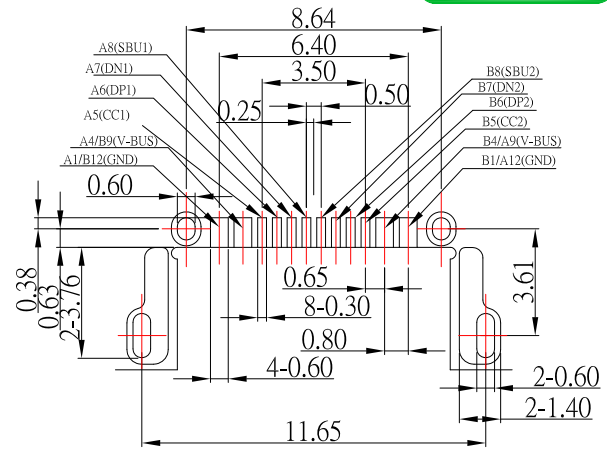
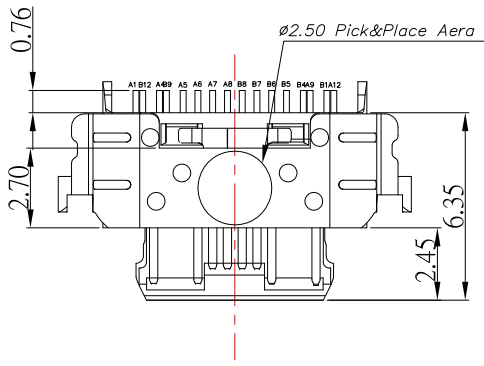




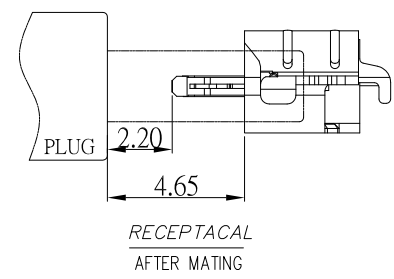
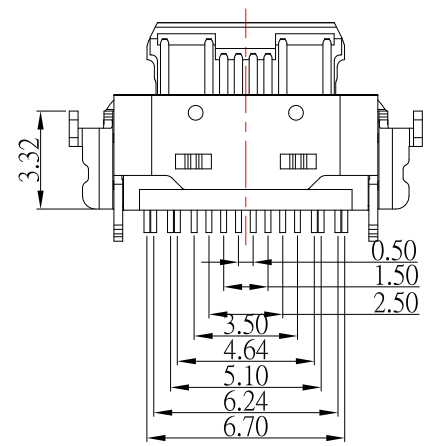
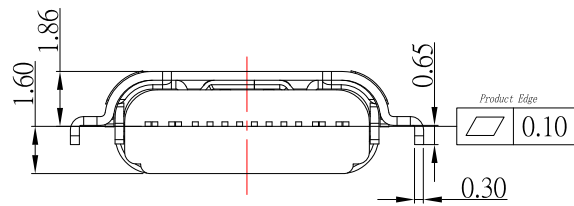
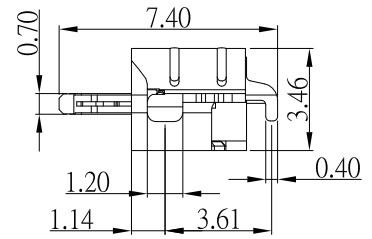
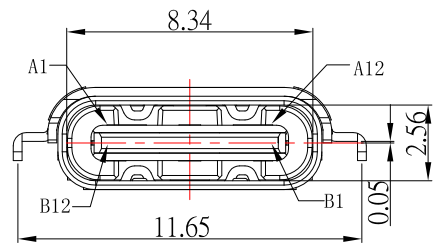
SBC-160M19H-20x-S331

鍍層厚度:

Blank : 1u"
2 : 15u"
3 : 30u"



RECOMMENDED P.C.B. LAYOUT



SPECIFICATIONS

Electrical:

- 1.Rating: 5.0 V, 5.0 A
- 2.Dielectric Withstand Voltage: 100V AC
- 3.Contact Resistance: 40 mΩ Max
- 4.Insulation Resistance: 100 MΩ Min

Mechanical:

- 1.Connector Mate and Unmate Force
 - 1.1 Mate force: 5~20 N
 - 1.2 Unmate force: 8~20 N

Material:

- 1.Housing: LCP
- 2.Contact: C18150
- 3.Shell: SUS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

 東莞市高迪電子有限公司
DONG GUAN GAO DI ELECTRONICS CO., LTD

TOLERANCE UNLESS OTHERWISE STATED :	Up to 5 ±0.2 Above 5 ~ 15 ±0.3 Above 15 ~ 30 ±0.4 Above 30 ~ 50 ±0.5 Angle ±0.3°	3RD. ANGEL'S	UNITS	MM
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DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	03/08/23			
CHECKED BY:	DATE	FINISH	MODLE	USB TYPE C 2.0 沉板上 H1.86mm高導電銅
Jacky Chen	03/08/23			
APPROVED BY:	DATE	SCALE	DWG NO.	SBC-160M19H-20x-S331
Tony Kao	03/08/23	1 : 1	PART NO.	SBC-160M19H-20x-S331
		SHEET NO.	1 of 1	

ITEM NO.	DESCRIPTION	DRAWN	DATE